

STGF6M65DF2

Trench gate field-stop IGBT, M series 650 V, 6 A low loss

Datasheet - production data

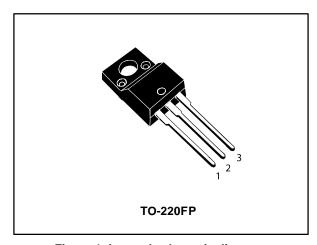
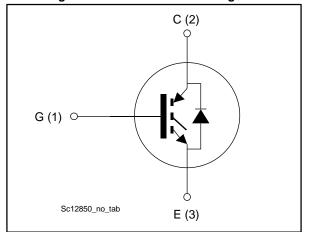


Figure 1: Internal schematic diagram



Features

- 6 µs of short-circuit withstand time
- V_{CE(sat)} = 1.55 V (typ.) @ I_C = 6 A
- Tight parameter distribution
- Safer paralleling
- Low thermal resistance
- Soft and very fast recovery antiparallel diode

Applications

- Motor control
- UPS
- PFC

Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where low-loss and short-circuit functionality are essential. Furthermore, the positive $V_{\text{CE(sat)}}$ temperature coefficient and tight parameter distribution result in safer paralleling operation.

Table 1: Device summary

Order code	Marking	Package	Packing
STGF6M65DF2	G6M65DF2	TO-220FP	Tube

Contents STGF6M65DF2

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STGF6M65DF2 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vces	Collector-emitter voltage (V _{GE} = 0 V)	650	V
Ic ⁽¹⁾	Continuous collector current at T _C = 25 °C	12	Α
IC(**	Continuous collector current at T _C = 100 °C	6	Α
Icp ⁽²⁾	Pulsed collector current	24	Α
V_{GE}	Gate-emitter voltage	±20	V
l _E ⁽¹⁾	Continuous forward current at T _C = 25 °C	12	Α
IF' /	Continuous forward current at T _C = 100 °C	6	Α
I _{FP} ⁽²⁾	Pulsed forward current		Α
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s, T_C = 25 °C)	2.5	kV
Ртот	Total dissipation at T _C = 25 °C	24.2	W
T _{STG}	Storage temperature range	- 55 to 150	°C
TJ	Operating junction temperature range - 55 to 175 °C		°C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal resistance junction-case IGBT	6.2	°C/W
R _{th} JC	Thermal resistance junction-case diode	7	°C/W
R _{thJA}	Thermal resistance junction-ambient	62.5	°C/W

 $^{^{(1)}}$ Limited by maximum junction temperature.

 $[\]ensuremath{^{(2)}}\mbox{Pulse}$ width limited by maximum junction temperature.

Electrical characteristics STGF6M65DF2

2 Electrical characteristics

 $T_C = 25$ °C unless otherwise specified

Table 4: Static characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage	$V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$	650			V
		V _{GE} = 15 V, I _C = 6 A		1.55	2.0	
V _{CE(sat)}	V _{CE(sat)} Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 6 A, T _J = 125 °C		1.9		V
		V _{GE} = 15 V, I _C = 6 A, T _J = 175 °C		2.1		
		I _F = 6 A		2.2		
VF	Forward on-voltage	I _F = 6 A, T _J = 125 °C		2.0		V
		I _F = 6 A, T _J = 175 °C		1.9		
V _{GE(th)}	Gate threshold voltage	V _{CE} = V _{GE} , I _C = 250 μA	5	6	7	V
Ices	Collector cut-off current	V _{GE} = 0 V, V _{CE} = 650 V			25	μΑ
I _{GES}	Gate-emitter leakage current	$V_{CE} = 0 \text{ V}, V_{GE} = \pm 20 \text{ V}$			±250	μΑ

Table 5: Dynamic characteristics

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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Cies	Input capacitance		-	530	-	
Coes	Output capacitance $V_{CE} = 25 \text{ V}, f = 1 \text{ MHz}, V_{CF} = 0 \text{ V}$		-	31	-	pF
Cres	Reverse transfer capacitance	VGL — V	-	11	-	
Qg	Total gate charge	Vcc = 520 V, Ic = 6 A,	-	21.2	-	
Qge	Gate-emitter charge $V_{GE} = 15 \text{ V}$ (see <i>Figure 30</i> :		-	5.2	-	nC
Q _{gc}	Gate-collector charge	" Gate charge test circuit")	-	8.8	-	

Table 6: IGBT switching characteristics (inductive load)

Table 6: IGBT switching characteristics (inductive load)						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time		-	15	1	ns
t _r	Current rise time		-	5.8	-	ns
(di/dt) _{on}	Turn-on current slope		-	828	-	A/µs
$t_{\text{d(off)}}$	Turn-off-delay time	V 400 V I 6 A V 45 V	-	90	-	ns
t _f	Current fall time	$V_{CE} = 400 \text{ V}, I_{C} = 6 \text{ A}, V_{GE} = 15 \text{ V},$ $R_{G} = 22 \Omega \text{ (see } Figure 29: " Test circuit for inductive load switching")}$	-	130	-	ns
E _{on} ⁽¹⁾	Turn-on switching energy		-	0.036	1	mJ
E _{off} ⁽²⁾	Turn-off switching energy		-	0.200	-	mJ
Ets	Total switching energy			0.236	-	mJ
t _{d(on)}	Turn-on delay time			17	ı	ns
tr	Current rise time		-	7	-	ns
(di/dt) _{on}	Turn-on current slope		-	685	-	A/µs
$t_{\text{d(off)}}$	Turn-off-delay time	V 400 V I 0 A V 45 V	-	86	-	ns
t _f	Current fall time	$V_{CE} = 400 \text{ V}$, $I_{C} = 6 \text{ A}$, $V_{GE} = 15 \text{ V}$, $R_{G} = 25 \Omega \text{ T}_{J} = 175 ^{\circ}\text{C}$ (see <i>Figure 29: " Test circuit for inductive load switching"</i>)	-	205	-	ns
E _{on} ⁽¹⁾	Turn-on switching energy	,	-	0.064	-	mJ
E _{off} ⁽²⁾	Turn-off switching energy		-	0.290	-	mJ
E _{ts}	Total switching energy			0.354	-	mJ
+	Short-circuit	$V_{CC} \le 400 \text{ V}, V_{GE} = 15 \text{ V}, T_{Jstart} = 150 \text{ °C}$	6		-	II.C
t _{sc}	withstand time	V _{CC} ≤ 400 V, V _{GE} = 13 V, T _{Jstart} = 150 °C	10		-	μs

Notes:

 $^{^{(1)}}$ Turn-on switching energy includes reverse recovery of the diode.

 $[\]ensuremath{^{(2)}}\mbox{Turn-off}$ switching energy also includes the tail of the collector current.

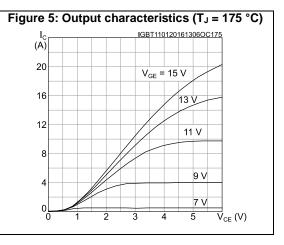
Table 7: Diode switching characteristics (inductive load)

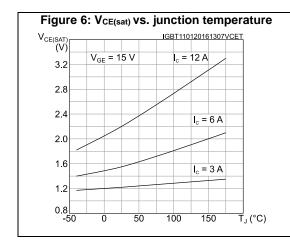
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Oyillboi	i arameter	rest conditions	141111.	ıyp.	wax.	Oilit
t _{rr}	Reverse recovery time		-	140		ns
Q _{rr}	Reverse recovery charge		-	210		nC
Irrm	Reverse recovery current	IF = 6 A, VR = 400 V, VGE = 15 V (see Figure 29: " Test circuit for inductive load switching")	-	6.6		Α
dl _{rr} /dt	Peak rate of fall of reverse recovery current during t _b	di/dt = 1000 A/μs	-	430		A/µs
Err	Reverse recovery energy			16		μJ
t _{rr}	Reverse recovery time			200		ns
Qrr	Reverse recovery charge			473		nC
Irrm	Reverse recovery current	I _F = 6 A, V _R = 400 V, V _{GE} = 15 V T _J = 175 °C (see <i>Figure 29: " Test</i> <i>circuit for inductive load switching"</i>)	-	9.6		Α
dl _{rr} /dt	Peak rate of fall of reverse recovery current during t _b	di/dt = 1000 A/μs	-	428		A/µs
Err	Reverse recovery energy		-	32	_	μJ

STGF6M65DF2 Electrical characteristics

2.1 STGF6M65DF2 electrical characteristics curves

150





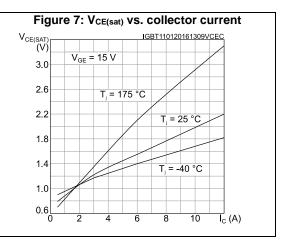


Figure 8: Collector current vs. switching frequency |C| = |C| =

f (kHz)

Figure 9: Forward bias safe operating area IGBT040820161324FSOA tp=1 µs 10¹ tp=10 µs tp=100 μs Single pulse, 10⁰ $T_C = 25$ °C p=1 ms TJ≤175 °C $V_{GE} = 15 V$ 10- $\overline{V}_{CE}(V)$ 10⁰ 10¹ 10²

Figure 11: Diode V_F vs. forward current

V_F
(V)

2.6

T_i = -40 °C

2.0

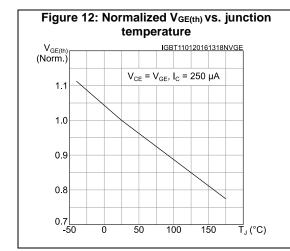
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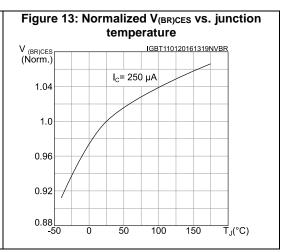
T_i = 175 °C

0.8

0.2

0 2 4 6 8 10 I_F (A)





STGF6M65DF2 Electrical characteristics

Figure 14: Capacitance variations

C
(pF)

10²

10¹

f = 1 MHz

C
C
res

10⁰

10⁻¹

10⁰

10¹

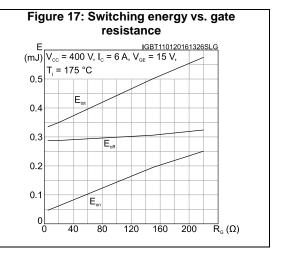
10²

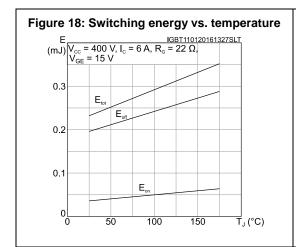
V_{CE} (V)

Figure 15: Gate charge vs. gate-emitter voltage

V_{GE} | IGBT110120161320GCGE |
(V) | V_{CC} = 520 V, I_C = 6 A, I_G = 1 mA |

12 | 8 |
4 | 0 | 0 | 5 | 10 | 15 | 20 | Q_g (nC)





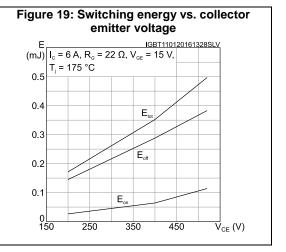


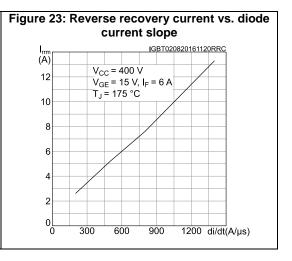
Figure 20: Short-circuit time and current vs. V_{GE} IGBT110120161330SCV (µs) Vcc ≤ 400 V, T_j ≤150 °C (A) 20 30 16 24 18 12 12

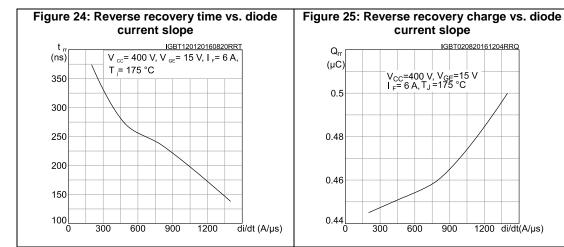
12 13 14

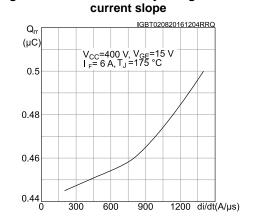
V _{GE}(V)

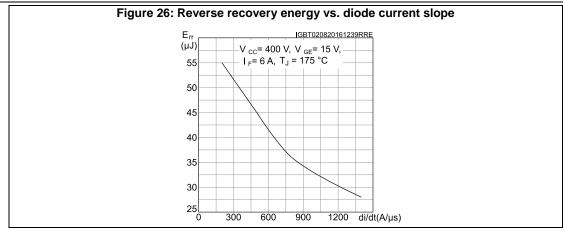
Figure 21: Switching times vs. collector current (ns) $V_{cc} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_{o} = 22 \Omega,$ $T_{j} = 175 ^{\circ}\text{C}$ 10 10⁰ 10 $\overline{\mathsf{I}}_{\mathsf{C}}(\mathsf{A})$

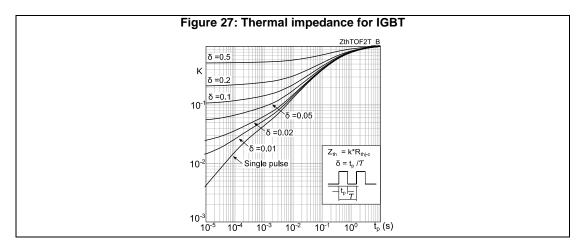
Figure 22: Switching times vs. gate resistance (ns) $V_{cc} = 400 \text{ V}, V_{GE} = 15 \text{ V}, I_c = 6 \text{ A},$ $T_j = 175 \text{ °C}$ 10^{2} 10¹ 80 120 160 200 $R_{G}(\Omega)$

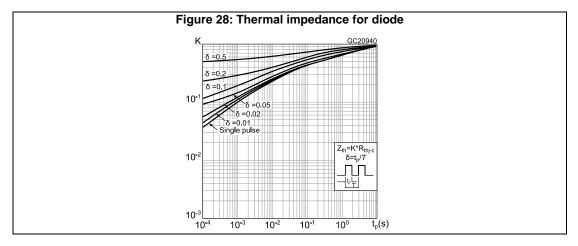






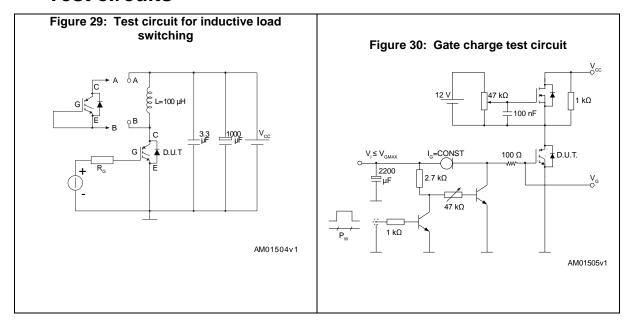


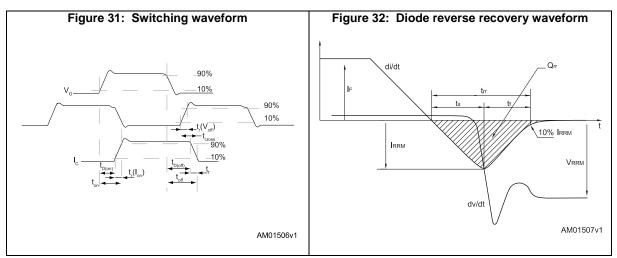




Test circuits STGF6M65DF2

3 Test circuits





STGF6M65DF2 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.



4.1 TO-220FP package information

Figure 33: TO-220FP package outline

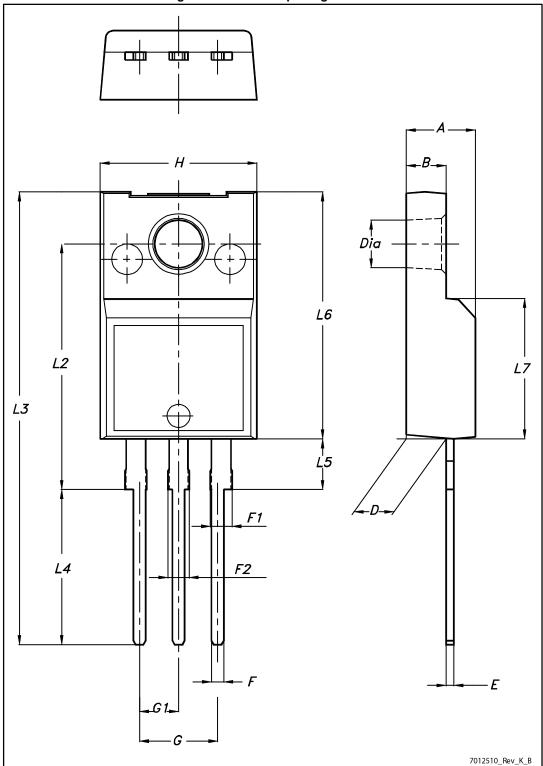


Table 8: TO-220FP package mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
Α	4.4		4.6
В	2.5		2.7
D	2.5		2.75
Е	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

Revision history STGF6M65DF2

5 Revision history

Table 9: Document revision history

Date	Revision	Changes
24-Nov-2015	1	First release.
24-Feb-2016	2	Document status promoted from preliminary to production data.
05-Aug-2016	3	Added Section 2.1: "STGF6M65DF2 electrical characteristics curves". Updated Section 1: "Electrical ratings" and Section 2: "Electrical characteristics".

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